

## 256K UVEPROM

UV Erasable Programmable  
Read-Only Memory

### AVAILABLE AS MILITARY SPECIFICATIONS

- -55°C to 125°C operation
- MILITARY Processing Methods
- Commercial Version Available

### FEATURES

- Organized 32,768 x 8
- Single +5V  $\pm 10\%$  power supply
- Pin-compatible with existing 256K ROM's and EPROM's
- All inputs/outputs fully TTL compatible
- Power-saving CMOS technology
- Very high-speed FLASHRITE Pulse Programming
- 3-state output buffers
- 400-mV DC assured noise immunity with standard TTL loads
- Latchup immunity of 250 mA on all input and output pins
- Low power dissipation (CMOS Input Levels)
  - Active - 165mW Worst Case
  - Standby - 1.7mW Worst Case (CMOS-input levels)

### OPTIONS

#### • Timing

120ns access	-12
150ns access	-15
170ns access	-17
200ns access	-20
250ns access	-25
300ns access	-30
55ns access	-55
70ns access	-70
90ns access	-90

#### • Package(s)

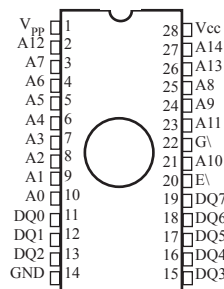
Ceramic DIP (600mils) J No. 110  
Ceramic LCC (450 x 550 mils) ECA No. 208

#### • Processing / Operating Temperature Ranges

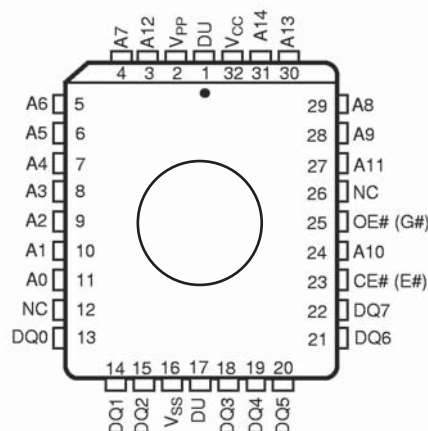
Full Military (-55°C to +125°C) M  
Industrial (-40°C to +85°C) I  
Military Temp (-55°C to +125°C) XT

### PIN ASSIGNMENT (Top View)

28-Pin DIP (J)  
(600 MIL)



32-Pin LCC (ECA)  
(450 x 550 mils)



Pin Name	Function
A0 - A14	Address Inputs
DQ0-DQ7	Inputs (programming)/Outputs
E\	Chip Enable/Power Down
G\	Output Enable
GND	Ground
V <sub>CC</sub>	5V Supply
V <sub>PP</sub>	13V Programming Power Supply

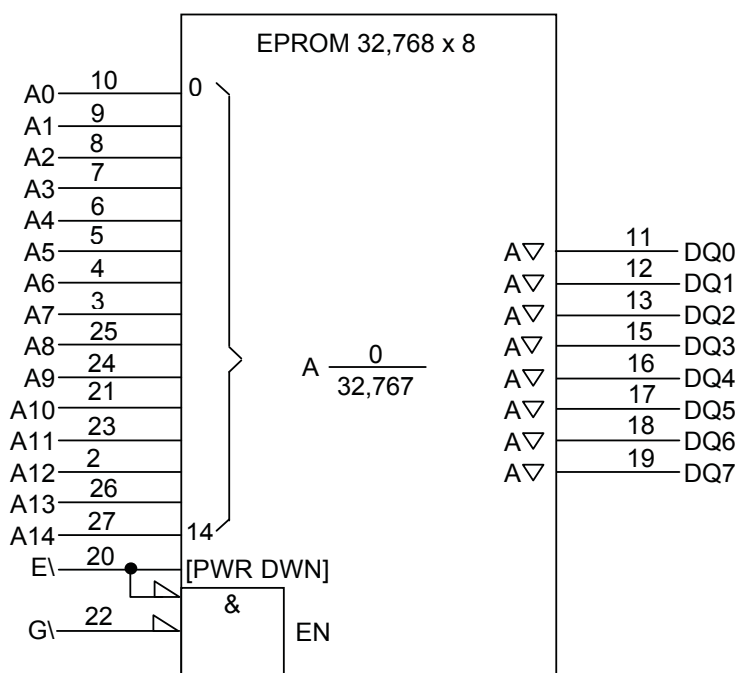
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## GENERAL DESCRIPTION

The AS27C256 series is a set of 262,144 bit, ultraviolet-light erasable, electrically programmable read-only memories. These devices are fabricated using power-saving CMOS technology for high speed and simple interface with MOS and bipolar circuits. All inputs (including program data inputs) can be driven by Series 54 TTL circuits without the use of external pullup resistors. Each output can drive one Series 54 TTL circuit without external resistors. The data outputs are 3-state for connecting multiple devices to a common bus. The AS27C256 is pin-compatible with 28-pin 256K ROMs and EPROMs. It is offered in a 600mil dual-in-line ceramic package (J suffix) and a 450 x 550 mil ceramic LCC (ECA suffix) rated for operation from -55°C to 125°C.

Because this EPROM operates from a single 5V supply (in the read mode), it is ideal for use in microprocessor-based systems. One other supply (12.75V) is needed for programming. All programming signals are TTL level. This device is programmable by the AMD FLASHRITE Pulse programming algorithm. The FLASHRITE Pulse programming algorithm uses a  $V_{pp}$  of 12.75V and a  $V_{cc}$  of 6.25V for a nominal programming time of four seconds. For programming outside the system, existing EPROM programmers can be used. Locations can be programmed singly, in blocks, or at random.

## FUNCTIONAL BLOCK DIAGRAM\*



\* This symbol is in accordance with ANSI/IEEE std 91-1984 and IEC Publication 617-12.

## OPERATION

The seven modes of operation for the AS27C256 are listed in Table 1. The read mode requires a single 5V supply. All inputs are TTL level except for  $V_{pp}$  during programming (12.75V for FLASHRITE Pulse), and (12V) on A9 for signature mode.

**TABLE 1. OPERATION MODES**

FUNCTION (PINS)	MODE*						
	READ	OUTPUT DISABLE	STANDBY	PROGRAMMING	VERIFY	PROGRAM INHIBIT	SIGNATURE MODE
E\	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_{IL}$	$V_{IH}$	$V_{IH}$	$V_{IL}$
G\	$V_{IL}$	$V_{IH}$	X	$V_{IH}$	$V_{IL}$	X	$V_{IL}$
$V_{PP}$	X <sup>1</sup>	X <sup>1</sup>	X <sup>1</sup>	$V_{PP}$	$V_{PP}$	$V_{PP}$	$V_{CC}$
$V_{CC}$	$V_{CC}$	$V_{CC}$	$V_{CC} \pm .3V$	$V_{CC}$	$V_{CC}$	$V_{CC}$	$V_{CC}$
A9	X	X	X	X	X	X	$V_{ID}^2$ $V_{ID}^2$
A0	X	X	X	X	X	X	$V_{IL}$ $V_{IH}$
DQ0-DQ7	Data Out	High-Z	High-Z	Data In	Data Out	High-Z	CODE**
							MFG   DEVICE
							01h   10h

<sup>1</sup>For normal standby & read operation,  $V_{PP}$  is Don't Care X.

<sup>2</sup>  $V_{ID} = 12V \pm .5V$

## NOTES:

\* X can be  $V_{IL}$  or  $V_{IH}$

\*\* Die is AMD. User can program on benchtop programmer by selecting AM27C256 from the device type selection menu.

### READ/OUTPUT DISABLE

When the outputs of two or more AS27C256 are connected in parallel on the same bus, the output of any particular device in the circuit can be read with no interference from the competing outputs of the other devices. To read the output of the selected AS27C256, a low-level signal is applied to  $E\backslash$  and  $G\backslash$ . All other devices in the circuit should have their outputs disabled by applying a high-level signal to one of these pins. Output data is accessed at pins DQ0 through DQ7.

### LATCHUP IMMUNITY

Latchup immunity on the AS27C256 is a minimum of 250mA on all inputs and outputs. This feature provides latchup immunity beyond any potential transients at the printed circuit board level when the EPROM is interfaced to industry standard TTL or MOS logic devices. Input/output layout approach controls latchup without compromising performance or packing density.

### POWER DOWN

Active  $I_{CC}$  supply current can be reduced from 25mA (AS27C256-12 through AS27C256-25) to 1mA (TTL-level inputs) or 300 $\mu$ A (CMOS-level inputs) by applying a high TTL/CMOS signal to the  $E\backslash$  pin. In this mode all outputs are in the high-impedance state.

### ERASURE

Before programming, the AS27C256 is erased by exposing the chip through the transparent lid to a high-intensity ultraviolet light (wavelength 2537 Å). EPROM erasure before programming is necessary to ensure that all bits are in the logic-high state. Logic-lows are programmed into the desired locations. A programmed logic-low can be erased only by ultraviolet light. The recommended minimum exposure dose (UV intensity x exposure time) is 15W•s/cm<sup>2</sup>. A typical 12mW/cm<sup>2</sup>, filterless UV lamp erases the device in 21 minutes. The lamp should be located about 2.5cm above the chip during erasure. After erasure, all bits are in the high state. It should be noted that normal ambient light contains the correct wavelength for erasure; therefore, when using the AS27C256, the window should be covered with an opaque label.

### FLASHRITE PULSE PROGRAMMING

The AS27C256 EPROM is programmed by using the AMD FLASHRITE Pulse programming algorithm as illustrated by the flowchart in Figure 1. This algorithm programs the device in a nominal time of 4 seconds. Actual programming time varies as a function of the programmer used.

Data is presented in parallel (eight bits) on pins DQ0 to DQ7. Once addresses and data are stable,  $E\backslash$  is pulsed.

The FLASHRITE Pulse programming algorithm uses initial pulses of 100 microseconds ( $\mu$ s) followed by a byte-verification step to determine when the addressed byte has been successfully programmed. Up to 25 100 $\mu$ s pulses per byte are provided before a failure is recognized.

The programming mode is achieved when  $V_{PP} = 12.75V$ ,  $V_{CC} = 6.25V$ ,  $G\backslash = V_{IH}$ , and  $E\backslash = V_{IL}$ . More than one device can be programmed when the devices are connected in parallel. Locations can be programmed in any order. When the AMD FLASHRITE Pulse programming routine is completed, all bits are verified with  $V_{CC} = V_{PP} = 5V$ .

### PROGRAM INHIBIT

Programming can be inhibited by maintaining a high-level input on  $E\backslash$ .

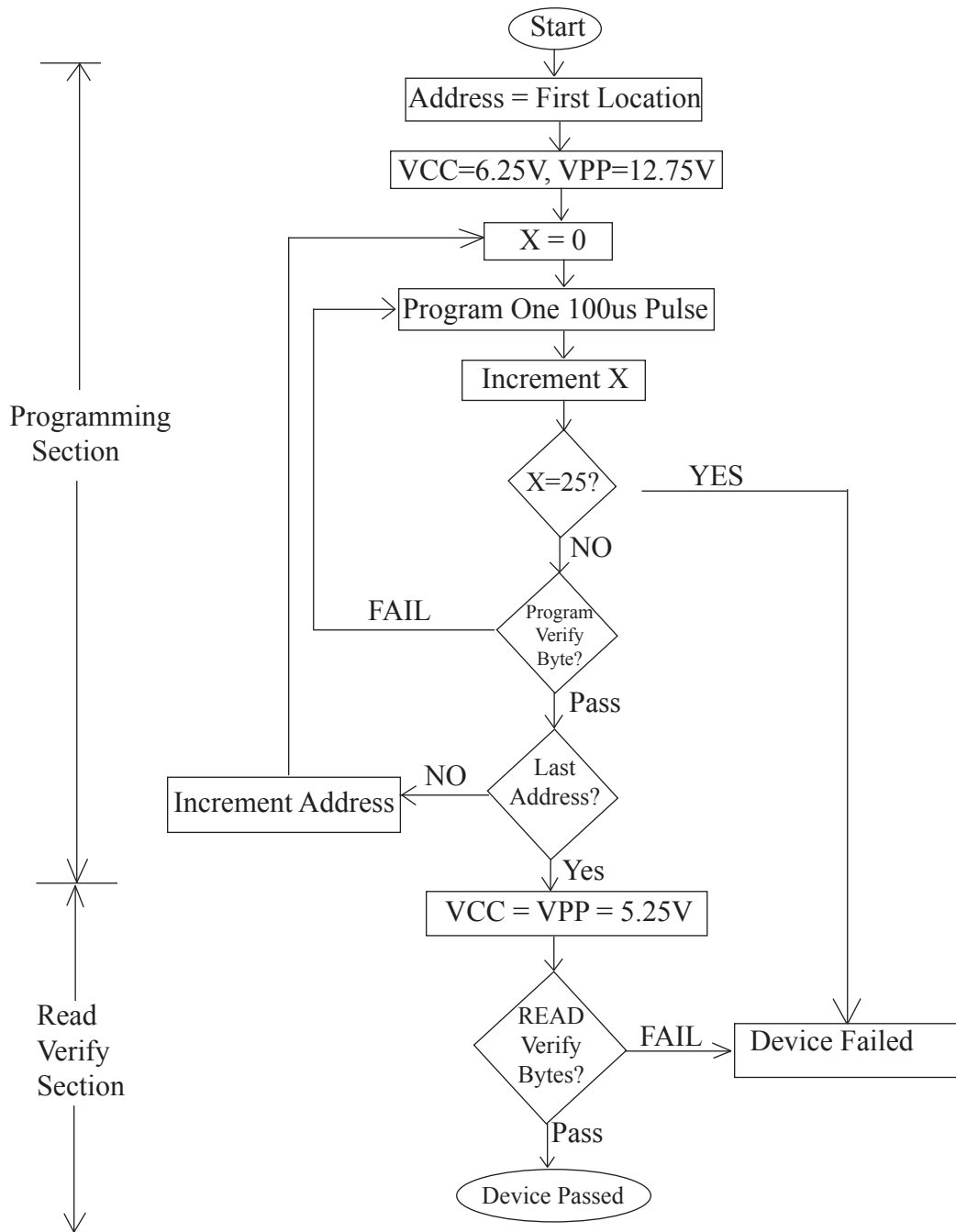
### PROGRAM VERIFY

Programmed bits can be verified with  $V_{PP} = 12.75V$  when  $G\backslash = V_{IL}$ , and  $E\backslash = V_{IH}$ .

### SIGNATURE MODE

The signature mode provides access to a binary code identifying the manufacturer and device type. This mode is activated when A9 is forced to 12V  $\pm$ 0.5V. Two identifier bytes are accessed by A0 (terminal 10); i.e.,  $A0 = V_{IL}$  accesses the manufacturer code, which is output on DQ0-DQ7;  $A0 = V_{IH}$  accesses the device code, which is also output on DQ0-DQ7. All other addresses must be held at  $V_{IL}$ . Each byte contains odd parity on bit DQ7. The manufacturer code for these devices is 01h and the device code is 10h.

**FIGURE 1. FLASHRITE PULSE PROGRAMMING FLOWCHART**





**CAPACITANCE OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERATING FREE-AIR TEMPERATURE,  $f = 1\text{MHz}^*$** 

PARAMETER		TEST CONDITIONS	TYP**	MAX	UNIT
$C_i$	Input capacitance	$V_I = 0\text{V}$	6	10	pF
$C_o$	Output capacitance	$V_O = 0\text{V}$	10	14	pF

\* Capacitance measurements are made on a sample basis only.

\*\* Typical values are at  $T_A = 25^\circ\text{C}$  and nominal voltages.

**SWITCHING CHARACTERISTICS OVER RECOMMENDED RANGES OF SUPPLY VOLTAGE AND OPERATING FREE-AIR TEMPERATURE<sup>1,2</sup>**

PARAMETER		TEST CONDITIONS <sup>1,2</sup>	-55		-70		-90		-12		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_{a(A)}$	Access time from address	see Figure 2		55		70		90		120	ns
$t_{a(E)}$	Access time from $E\backslash$			55		70		90		120	ns
$t_{en(G)R}$	Output enable time from $G\backslash$			35		40		40		40	ns
$t_{dis}$	Disable time of output from $G\backslash$ or $E\backslash$ , whichever occurs first <sup>3</sup>		0	30	0	30	0	30	0	30	ns
$t_{v(A)}$	Output data valid time after change of address, $E\backslash$ , or $G\backslash$ , whichever occurs first <sup>3</sup>		0		0		0		0		ns

PARAMETER		TEST CONDITIONS <sup>1,2</sup>	-15		-17		-20		-25		-30		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$t_{a(A)}$	Access time from address	see Figure 2		150		170		200		250		300	ns
$t_{a(E)}$	Access time from $E\backslash$			150		170		200		250		300	ns
$t_{en(G)R}$	Output enable time from $G\backslash$			50		50		60		60		60	ns
$t_{dis}$	Disable time of output from $G\backslash$ or $E\backslash$ , whichever occurs first <sup>3</sup>		0	30	0	40	0	50	0	60	0	60	ns
$t_{v(A)}$	Output data valid time after change of address, $E\backslash$ , or $G\backslash$ , whichever occurs first <sup>3</sup>		0		0		0		0		0		ns

**NOTES:**

1. Timing measurements are made at 2V for logic high and 0.8V for logic low (see figure 2).

2. Common test conditions apply for  $t_{dis}$  except during programming.

3. Value calculated from 0.5V delta to measured output level. This parameter is only sampled and not 100% tested.

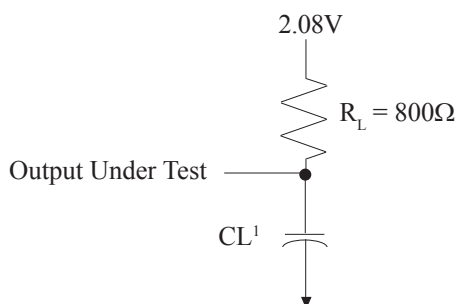
**SWITCHING CHARACTERISTICS FOR PROGRAMMING:  $V_{CC} = 6.5\text{V}$  and  $V_{PP} = 12.75\text{V}$  (AMD FLASHRITE ALGO),  $T_A = 25^\circ\text{C}$** 

PARAMETER		MIN	MAX	UNIT
$t_{dis(G)}$	Output disable time from $G\backslash$	0	130	ns
$t_{en(G)W}$	Output enable time from $G\backslash$		150	ns

**RECOMMENDED TIMING REQUIREMENTS FOR PROGRAMMING:  $V_{CC} = 6.5$  and  $V_{PP} = 12.75V$  (AMD FLASHRITE ALGO),  $T_A = 25^\circ C$  (See Figure 2)**

		MIN	TYP	MAX	UNIT
$t_{h(A)}$	Hold Time, Address	0			$\mu s$
$t_{h(D)}$	Hold Time, Data	2			$\mu s$
$t_{w(E)PR}$	Pulse Duration, Initial Program	95	100	105	$\mu s$
$t_{su(A)}$	Setup Time, Address	2			$\mu s$
$t_{su(G)}$	Setup Time, G\	2			$\mu s$
$t_{su(E)}$	Setup Time, E\	2			$\mu s$
$t_{su(D)}$	Setup Time, Data	2			$\mu s$
$t_{su(VPP)}$	Setup Time, $V_{PP}$	2			$\mu s$
$t_{su(VCC)}$	Setup Time, $V_{CC}$	2			$\mu s$

## PARAMETER MEASUREMENT INFORMATION

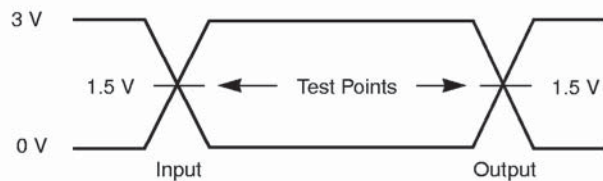


### NOTES:

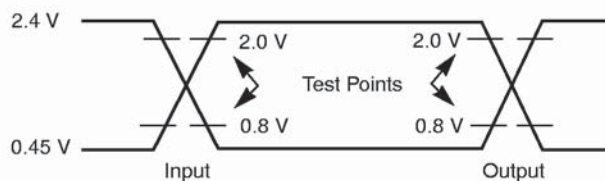
1.  $C_L$  includes probe and fixture capacitance.

## TEST SPECIFICATIONS

Test Condition	-55, -70 and -90	All Others	Unit
Output Load	1 TTL gate		
Output Load Capacitance, $C_L$ (including jig capacitance)	30	100	pF
Input Rise and Fall Times	$\leq 20$		ns
Input Pulse Levels	0.0-3.0	0.45-2.4	V
Input timing measurement reference levels	1.5	0.8, 2.0	V
Output timing measurement reference levels	1.5	0.8, 2.0	V



**Note:** For  $C_L = 30$  pF.



**Note:** For  $C_L = 100$  pF.

**FIGURE 2. LOAD CIRCUIT AND VOLTAGE WAVEFORMS**



FIGURE 3. READ-CYCLE TIMING

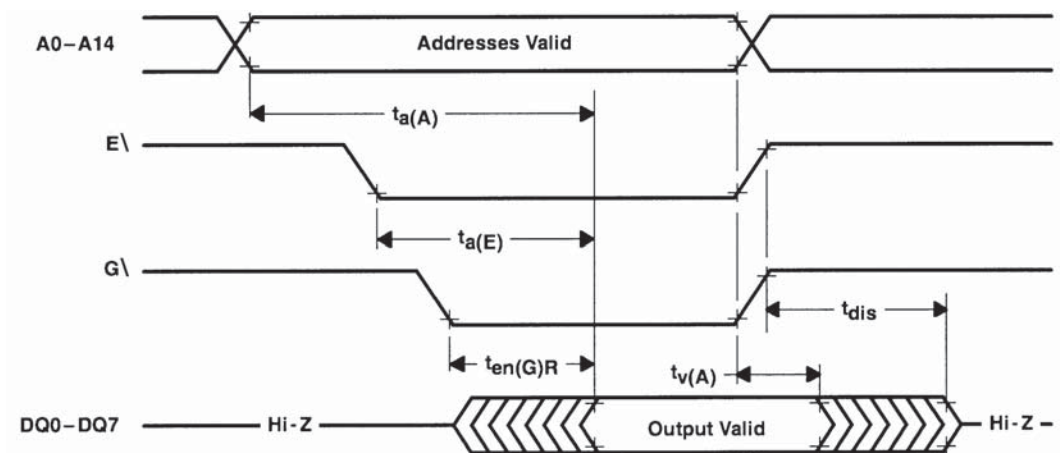
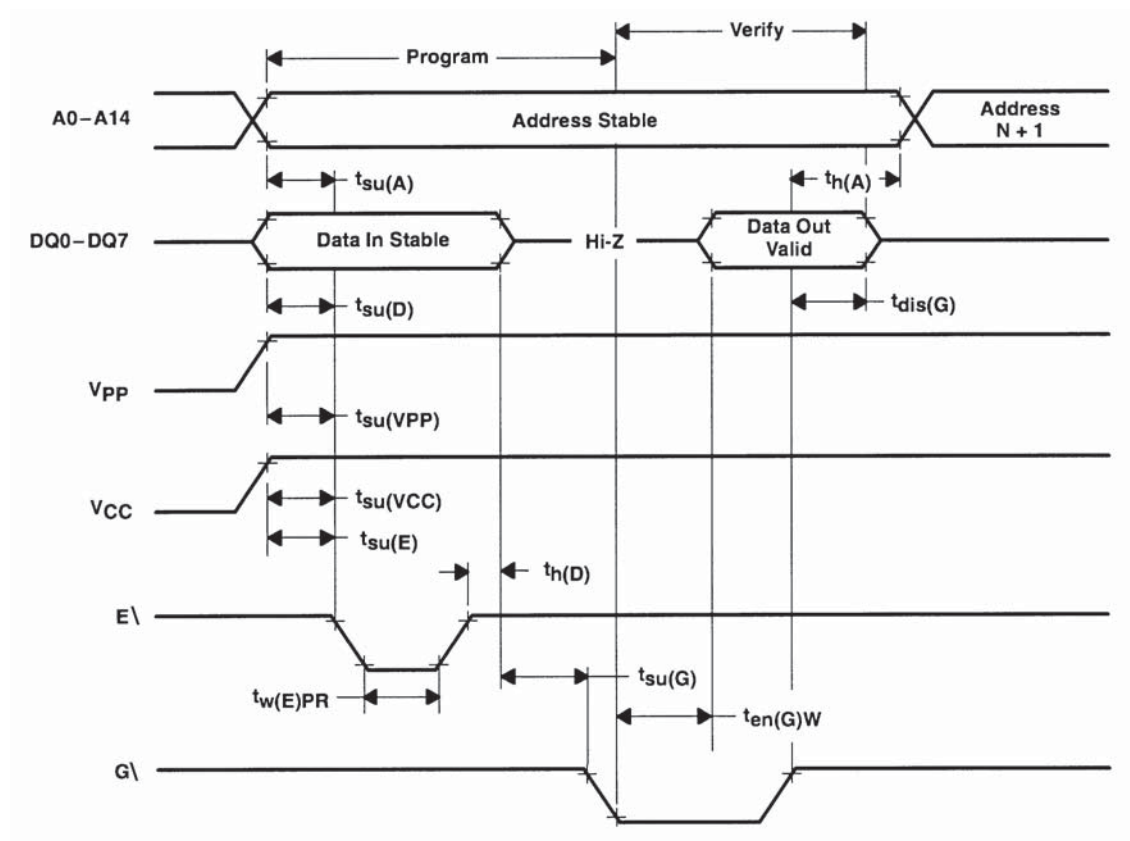
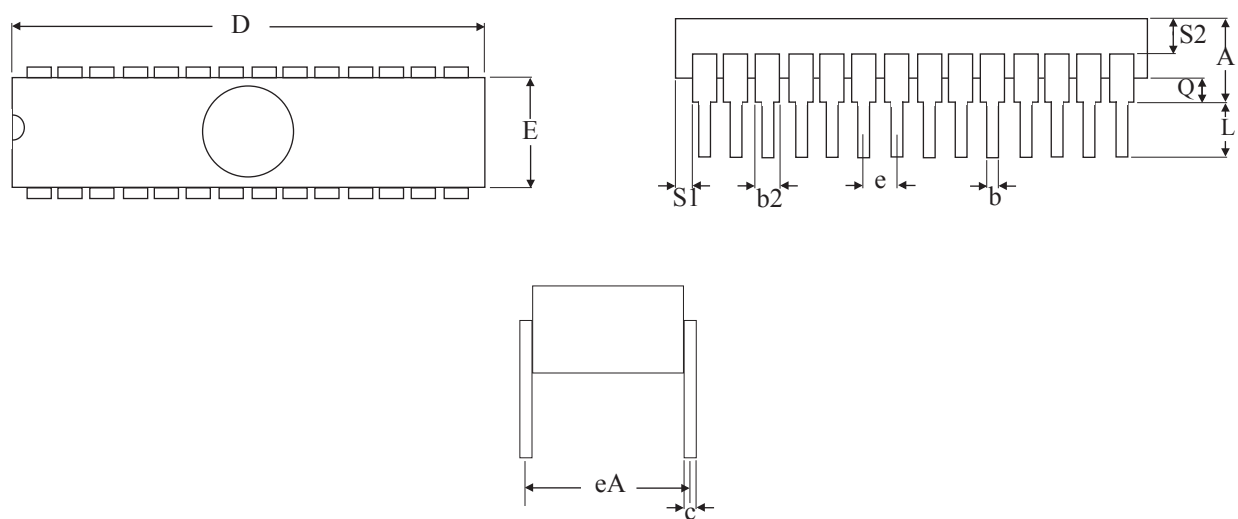


FIGURE 4. PROGRAM-CYCLE TIMING (FLASHRITE PULSE PROGRAMMING)



## MECHANICAL DEFINITION\*

### Micross Case #110 (Package Designator J)

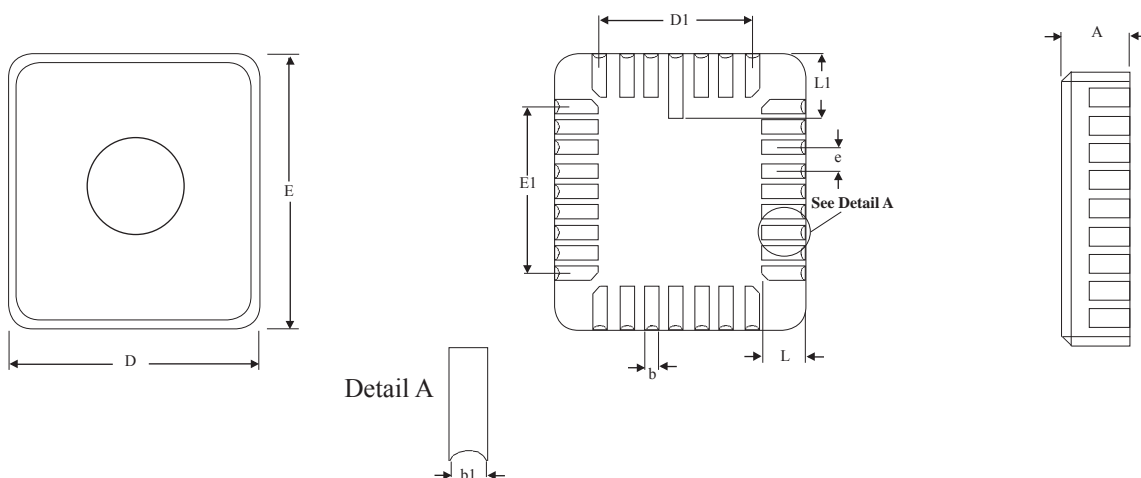


Symbol	SMD Specifications	
	MIN	MAX
A	---	0.232
b	0.014	0.026
b2	0.045	0.065
c	0.008	0.018
D	---	1.490
E	0.500	0.610
eA	0.600 BSC	
e	0.100 BSC	
L	0.125	0.200
Q	0.015	0.060
S1	0.005	---
S2	0.005	---

\*All measurements are in inches.

## MECHANICAL DEFINITIONS\*

### Micross Case #208 (Package Designator ECA)



SYMBOL	SMD SPECIFICATIONS	
	MIN	MAX
A	0.060	0.120
b	0.022	0.028
b1	0.006	0.022
D	0.442	0.458
D1	0.300 BSC	
E	0.540	0.560
E1	0.400 BSC	
e	0.050 BSC	
L	0.045	0.055
L1	0.075	0.095

\*All measurements are in inches.

## ORDERING INFORMATION

**EXAMPLE: AS27C256-30JM/MIL**

Device Number	Speed	Package Type	Operating Temp.
<b>AS27C256</b>	<b>-55</b>	<b>J</b>	*
<b>AS27C256</b>	<b>-70</b>	<b>J</b>	*
<b>AS27C256</b>	<b>-90</b>	<b>J</b>	*
AS27C256	-12	J	*
AS27C256	-15	J	*
AS27C256	-17	J	*
AS27C256	-20	J	*
AS27C256	-25	J	*
AS27C256	-30	J	*

**EXAMPLE: AS27C256-15ECAM**

Device Number	Speed	Package Type	Operating Temp.
<b>AS27C256</b>	<b>-55</b>	<b>ECA</b>	*
<b>AS27C256</b>	<b>-70</b>	<b>ECA</b>	*
<b>AS27C256</b>	<b>-90</b>	<b>ECA</b>	*
AS27C256	-12	ECA	*
AS27C256	-15	ECA	*
AS27C256	-17	ECA	*
AS27C256	-20	ECA	*
AS27C256	-25	ECA	*
AS27C256	-30	ECA	*

**\*PROCESS / OPERATING TEMPERATURE**

M = Full Military Processing Per MIL-PRF-38535, Class Q	-55°C to +125°C
I = Industrial Temperature Range	-40°C to +85°C
XT = Military Temperature Range	-55°C to +125°C

## SMD ORDERING INFORMATION

SMD	ASI PN	SPEED	PACKAGE
5962-8606301XA	AS27C256 -20JM	200ns	600mil, 28LD. DIP
5962-8606311XA	AS27C256 -20JM	200ns	600mil, 28LD. DIP
5962-8606302XA	AS27C256 -25JM	250ns	600mil, 28LD. DIP
5962-8606312XA	AS27C256 -25JM	250ns	600mil, 28LD. DIP
5962-8606303XA	AS27C256 -30JM	300ns	600mil, 28LD. DIP
5962-8606313XA	AS27C256 -30JM	300ns	600mil, 28LD. DIP
5962-8606304XA	AS27C256 -17JM	170ns	600mil, 28LD. DIP
5962-8606314XA	AS27C256 -17JM	170ns	600mil, 28LD. DIP
5962-8606305XA	AS27C256 -15JM	150ns	600mil, 28LD. DIP
5962-8606315XA	AS27C256 -15JM	150ns	600mil, 28LD. DIP
5962-8606306XA	AS27C256 -12JM	120ns	600mil, 28LD. DIP
5962-8606316XA	AS27C256 -12JM	120ns	600mil, 28LD. DIP
5962-8606307XA	AS27C256 -90JM	90ns	600mil, 28LD. DIP
5962-8606317XA	AS27C256 -90JM	90ns	600mil, 28LD. DIP
5962-8606308XA	AS27C256 -70JM	70ns	600mil, 28LD. DIP
5962-8606318XA	AS27C256 -70JM	70ns	600mil, 28LD. DIP
5962-8606309XA	AS27C256 -55JM	55ns	600mil, 28LD. DIP
5962-8606319XA	AS27C256 -55JM	55ns	600mil, 28LD. DIP

SMD	ASI PN	SPEED	PACKAGE
5962-8606301YA	AS27C256 -20ECA	200ns	32-LD. 0.450 x 0.550, LCC
5962-8606311YA	AS27C256 -20ECA	200ns	32-LD. 0.450 x 0.550, LCC
5962-8606302YA	AS27C256 -25ECA	250ns	32-LD. 0.450 x 0.550, LCC
5962-8606312YA	AS27C256 -25ECA	250ns	32-LD. 0.450 x 0.550, LCC
5962-8606303YA	AS27C256 -30ECA	300ns	32-LD. 0.450 x 0.550, LCC
5962-8606313YA	AS27C256 -30ECA	300ns	32-LD. 0.450 x 0.550, LCC
5962-8606304YA	AS27C256 -17ECA	170ns	32-LD. 0.450 x 0.550, LCC
5962-8606314YA	AS27C256 -17ECA	170ns	32-LD. 0.450 x 0.550, LCC
5962-8606305YA	AS27C256 -15ECA	150ns	32-LD. 0.450 x 0.550, LCC
5962-8606315YA	AS27C256 -15ECA	150ns	32-LD. 0.450 x 0.550, LCC
5962-8606306YA	AS27C256 -12ECA	120ns	32-LD. 0.450 x 0.550, LCC
5962-8606316YA	AS27C256 -12ECA	120ns	32-LD. 0.450 x 0.550, LCC
5962-8606307YA	AS27C256 -90ECA	90ns	32-LD. 0.450 x 0.550, LCC
5962-8606317YA	AS27C256 -90ECA	90ns	32-LD. 0.450 x 0.550, LCC
5962-8606308YA	AS27C256 -70ECA	70ns	32-LD. 0.450 x 0.550, LCC
5962-8606318YA	AS27C256 -70ECA	70ns	32-LD. 0.450 x 0.550, LCC
5962-8606309YA	AS27C256 -55ECA	55ns	32-LD. 0.450 x 0.550, LCC
5962-8606319YA	AS27C256 -55ECA	55ns	32-LD. 0.450 x 0.550, LCC

**DOCUMENT TITLE**

256K UVEPROM UV Erasable Programmable Read-Only Memory

<b><u>Rev #</u></b>	<b><u>History</u></b>	<b><u>Release Date</u></b>	<b><u>Status</u></b>
2.2	Changed VIH, TTL and CMOS, to Max of Vcc+0.5V on page 6	June 2010	Release
2.3	Added -55, -70, -90 and -30 timings on page 7, added test specification chart and updated voltage waveforms on page 8	February 2011	Release